

2SB0976 (2SB976)

Silicon PNP epitaxial planer type

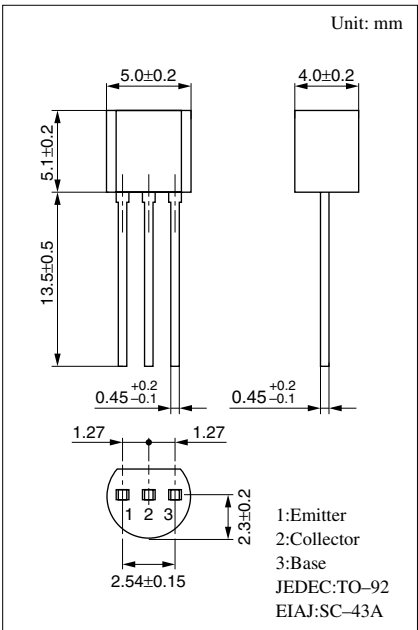
For low-frequency output amplification
 For DC-DC converter
 For stroboscope

Features

- Low collector to emitter saturation voltage $V_{CE(sat)}$.
- Large collector current I_C .

Absolute Maximum Ratings ($T_a=25^{\circ}\text{C}$)

Parameter	Symbol	Ratings	Unit
Collector to base voltage	V_{CBO}	-27	V
Collector to emitter voltage	V_{CEO}	-18	V
Emitter to base voltage	V_{EBO}	-7	V
Peak collector current	I_{CP}	-8	A
Collector current	I_C	-5	A
Collector power dissipation	P_C	0.75	W
Junction temperature	T_j	150	$^{\circ}\text{C}$
Storage temperature	T_{stg}	-55 ~ +150	$^{\circ}\text{C}$



Electrical Characteristics ($T_a=25^{\circ}\text{C}$)

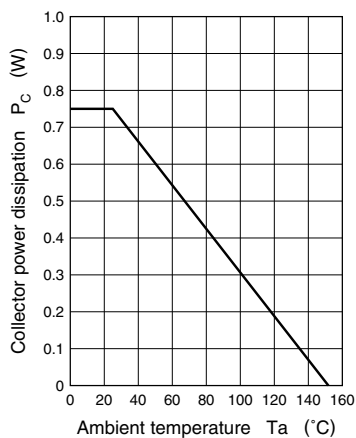
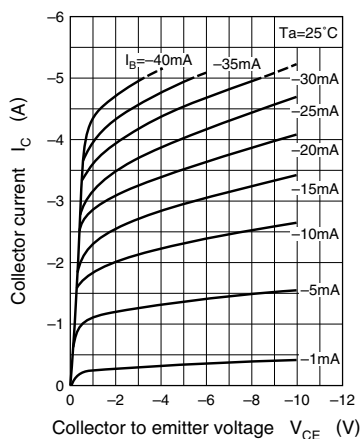
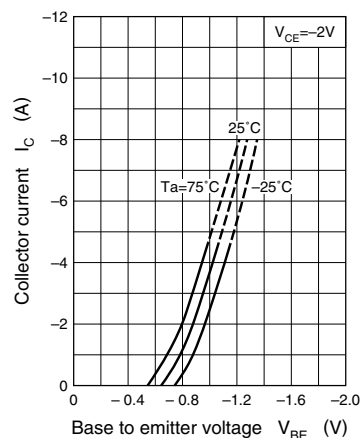
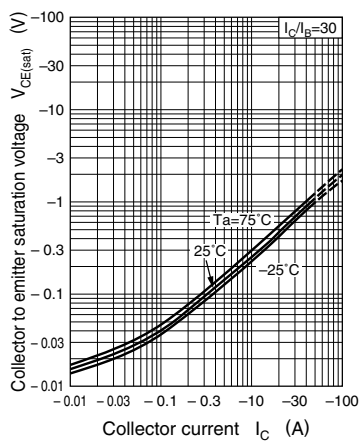
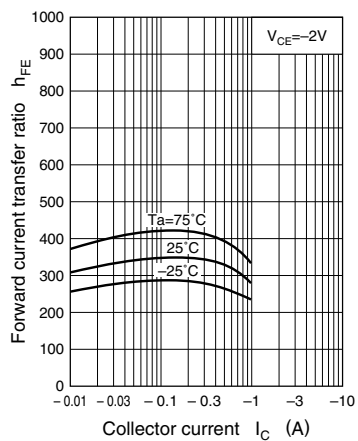
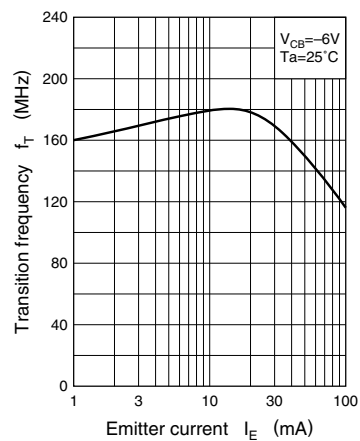
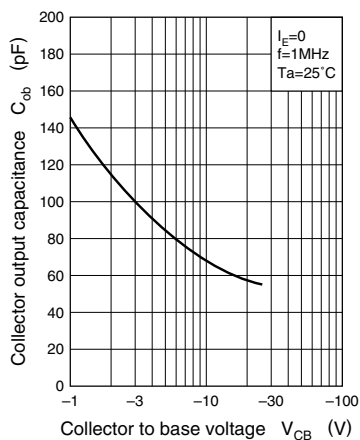
Parameter	Symbol	Conditions	min	typ	max	Unit
Collector cutoff current	I_{CBO}	$V_{CB} = -10\text{V}, I_E = 0$			-100	nA
Emitter cutoff current	I_{EBO}	$V_{EB} = -5\text{V}, I_C = 0$			-1	μA
Collector to emitter voltage	V_{CEO}	$I_C = -1\text{mA}, I_B = 0$	-18			V
Emitter to base voltage	V_{EBO}	$I_E = -10\mu\text{A}, I_C = 0$	-7			V
Forward current transfer ratio	h_{FE}^{*1}	$V_{CE} = -2\text{V}, I_C = -2\text{A}^{*2}$	125		625	
Collector to emitter saturation voltage	$V_{CE(sat)}$	$I_C = -3\text{A}, I_B = -0.1\text{A}^{*2}$		-0.4	-1	V
Transition frequency	f_T	$V_{CB} = -6\text{V}, I_E = 50\text{mA}, f = 200\text{MHz}$		120		MHz
Collector output capacitance	C_{ob}	$V_{CB} = -20\text{V}, I_E = 0, f = 1\text{MHz}$		60		pF

^{*2} Pulse measurement

^{*1} h_{FE} Rank classification

Rank	Q	R
h_{FE}	125 ~ 205	180 ~ 625

Note.) The Part number in the Parenthesis shows conventional part number.

$P_C - T_a$  $I_C - V_{CE}$  $I_C - V_{BE}$  $V_{CE(sat)} - I_C$  $h_{FE} - I_C$  $f_T - I_E$  $C_{ob} - V_{CB}$ 

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